

STGW45HF60WD

45 A, 600 V ultra fast IGBT

Preliminary data

Features

- Improved E_{off} at elevated temperature
- Low C_{RES} / C_{IES} ratio (no cross-conduction susceptibility)
- Ultra fast soft recovery antiparallel diode

Applications

- Welding
- High frequency converters
- Power factor correction



The "HF" series is based on a new planar technology concept to yield an IGBT with tighter variation of switching energy ($E_{\rm off}$) versus temperature. Suffix "W" denotes a subset of products tailored to high switching frequency operation over 100 kHz.

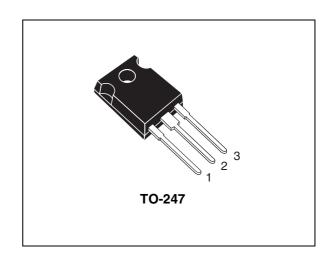


Figure 1. Internal schematic diagram

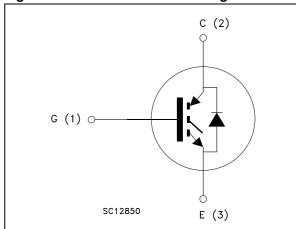


Table 1. Device summary

Order code	Marking	Package	Packaging
STGW45HF60WD	GW45HF60WD	TO-247	Tube

Electrical ratings STGW45HF60WD

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V
I _C ⁽¹⁾	Continuous collector current at T _C = 25 °C	70	Α
I _C ⁽¹⁾	Continuous collector current at T _C = 100 °C	45	Α
I _{CP} ⁽²⁾	Collector current (pulsed)	TBD	Α
I _{CL} (3)	Turn-off latching current	TBD	Α
V _{GE}	Gate-emitter voltage	± 20	V
I _F	Diode RMS forward current at T _C = 25 °C	30	Α
I _{FSM}	Surge not repetitive forward current t _p = 10 ms sinusoidal	120	Α
P _{TOT}	Total dissipation at T _C = 25 °C	250	W
T _{stg}	Storage temperature	– 55 to 150	
T _j	Operating junction temperature	- 55 10 150	°C

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Pulse width limited by maximum junction temperature and turn-off within RBSOA
- 3. V_{CLAMP} = 80% (V_{CES}), V_{GE} = 15 V, R_{G} = 10 Ω , T_{J} = 150 °C

Table 3. Thermal data

Symbol	Parameter	Value	Unit
B	Thermal resistance junction-case IGBT	0.5	°C/W
R _{thj-case}	Thermal resistance junction-case diode	1.5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	50	°C/W

2 Electrical characteristics

 $(T_J = 25 \, ^{\circ}C \text{ unless otherwise specified})$

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			V
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 30 A V _{GE} = 15V, I _C = 30 A,T _J = 125 °C		1.9 TBD	2.5	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_C = 1 \text{ mA}$	3.75		5.75	V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} = 600 V V _{CE} = 600 V, T _J = 125 °C			500 5	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ±20 V			± 100	nA
9fs	Forward transconductance	V _{CE} = 15 V _, I _C = 30 A		TBD		S

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{CE} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GE} = 0$	-	TBD TBD TBD	-	pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE} = 390 \text{ V, } I_{C} = 30 \text{ A,}$ $V_{GE} = 15 \text{ V,}$ Figure 3	-	TBD TBD TBD	-	nC nC nC

Electrical characteristics STGW45HF60WD

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 390 V, I_{C} = 30 A R_{G} = 4.7 Ω , V_{GE} = 15 V, Figure 2	-	TBD TBD TBD	-	ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}, I_{C} = 30 \text{ A}$ $R_{G} = 4.7 \Omega, V_{GE} = 15 \text{ V},$ $T_{J} = 125 \text{ °C } \textit{Figure 2}$	-	TBD TBD TBD	-	ns ns A/µs
$t_r(V_{off})$ $t_d(_{off})$ t_f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V, } I_{C} = 30 \text{ A,}$ $R_{GE} = 4.7 \Omega \text{ V}_{GE} = 15 \text{ V}$ Figure 2	-	TBD TBD TBD	-	ns ns ns
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V, } I_{C} = 30 \text{ A,}$ $R_{GE} = 4.7 \Omega V_{GE} = 15 \text{ V,}$ $T_{J} = 125 \text{ °C}$ Figure 2	-	TBD TBD TBD	-	ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{on} ⁽¹⁾	Turn-on switching losses	$V_{CC} = 390 \text{ V}, I_{C} = 30 \text{ A}$		300		μJ
E_{off}	Turn-off switching losses	$R_G = 4.7 \Omega, V_{GE} = 15 V,$	-	330		μJ
E _{ts}	Total switching losses	Figure 4		630		μJ
E _{on} ⁽¹⁾	Turn-on switching losses	$V_{CC} = 390 \text{ V}, I_{C} = 30 \text{ A}$		550		μJ
E_{off}	Turn-off switching losses	$R_G = 4.7 \Omega$, $V_{GE} = 15 V$,	-	550	800	μJ
E _{ts}	Total switching losses	T _J = 125 °C <i>Figure 4</i>		1100		μJ

Eon is the tun-on losses when a typical diode is used in the test circuit in *Figure 4*. If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25 °C and 125 °C). Eon include diode recovery energy.

Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _F	Forward on-voltage	I _F = 30 A I _F = 30 A, T _J = 125 °C	-	1.6 1.4	-	V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 30 \text{ A}, V_R = 50 \text{ V},$ di/dt = 100 A/ μ s (see Figure 5)	-	45 56 2.55	-	ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 30 \text{ A}, V_R = 50 \text{ V},$ $di/dt = 100 \text{ A/}\mu\text{s}$ $T_J = 125 ^{\circ}\text{C}, \text{ (see Figure 5)}$	-	100 290 5.8	-	ns nC A

STGW45HF60WD Test circuits

3 Test circuits

Figure 2. Test circuit for inductive load switching

Figure 3. Gate charge test circuit

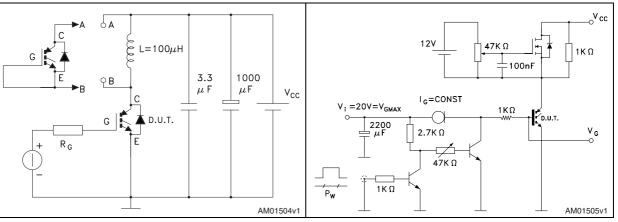
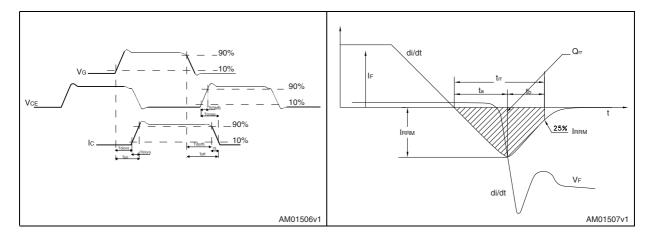


Figure 4. Switching waveform

Figure 5. Diode recovery time waveform



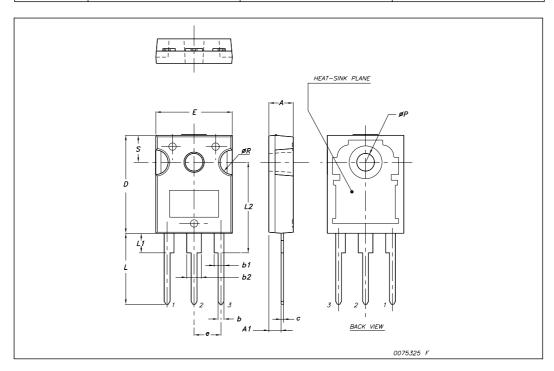
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

6/9 Doc ID 15593 Rev 2

TO-247 Mechanical data

Dim.		mm.	
Diiii.	Min.	Тур	Max.
Α	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
øΡ	3.55		3.65
øR	4.50		5.50
S		5.50	



Revision history STGW45HF60WD

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
16-Apr-2009	1	Initial release.
04-Aug-2009	2	 Modified I_C value on Test conditions <i>Table 4</i> Modified R_G value on Test conditions <i>Table 6</i> and <i>Table 7</i>

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